SUD50P04-08



Vishay Siliconix

RoHS COMPLIANT

HALOGEN

FREE

P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.)		
-40	0.0081 at V _{GS} = -10 V	-50 ^d	60		
-40	0.0117 at V_{GS} = -4.5 V	-48 ^d	00		

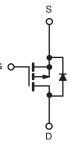


FEATURES

- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power switch
- Load switch in high current applications
- DC/DC converters



P-Channel MOSFET

Ordering Information:

SUD50P04-08-GE3 (lead (Pb)-free and halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless othe	rwise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	-40	M	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Duois Current (T. 150 °C)	T _C = 25 °C		-50 ^d	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	-50 ^d	_
Pulsed Drain Current	I _{DM}	-100	- A	
Avalanche Current	I _{AS}	-46		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	106	mJ
Maximum Power Dissipation ^a	T _C = 25 °C	Р	73.5 ^b	W
	T _A = 25 °C °	– P _D –	2.5	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W		
Junction-to-Case (Drain)	R _{thJC}	1.7	0/10		

Notes

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUD50P04-08



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-40	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	r	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = -40 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	-50		
		V_{DS} = -40 V, V_{GS} = 0 V, T_{J} = 150 °C	-	-	-250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}$ -10 V, $V_{GS}{=}$ -10 V	-50	-	-	А	
Drain-Source On-State Resistance a	Brach	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -22 \text{ A}$	-	0.0067	0.0081	Ω	
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -19 \text{ A}$	-	0.0097	0.0117		
Forward Transconductance ^a	g fs	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -22 \text{ A}$	-	45	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	5380	-	pF	
Output Capacitance	Coss	V_{GS} = 0 V, V_{DS} = -20 V, f = 1 MHz	-	570	-		
Reverse Transfer Capacitance	C _{rss}		-	500	-		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	106	159		
Total Gate Charge ^c	Qg		-	60	90		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = -20 V, V_{GS} = -4.5 V, I_{D} = -20 A	-	22	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	27	-		
Gate Resistance	Rg	f = 1 MHz	0.4	1.8	3.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	15	23		
Rise Time ^c	t _r	$V_{DD} = -20 V, R_1 = 2 \Omega$	-	12	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ -10 Å, V_{GEN} = -10 V, R_g = 1 Ω	-	70	105	- ns	
Fall Time ^c	t _f		-	18	27		
Drain-Source Body Diode Ratings a	nd Characteri	stics (T _C = 25 °C) ^b					
Continuous Current	I _S		-	-	-50		
Pulsed Current	I _{SM}		-	-	-100	A	
Forward Voltage ^a	V _{SD}	I _F = -10 A, V _{GS} = 0 V	-	-0.8	-1.5	V	
Reverse Recovery Time	trr		-	35	53	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = -10 A, dl/dt = 100 A/μs	-	-2	-3	А	
Reverse Recovery Charge	Q _{rr}		_	33	50	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

0.015 V_{GS} = 10 V thru 5 V

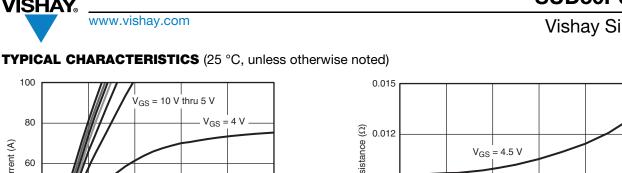
 $V_{GS} = 3 V$

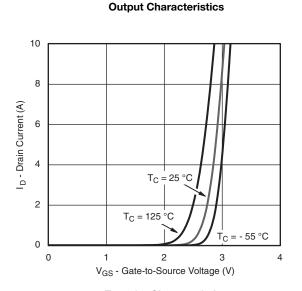
2.0

2.5

1.5

V_{DS} - Drain-to-Source Voltage (V)





'ISHAY

100

80

60

40

20

0

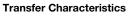
0.0

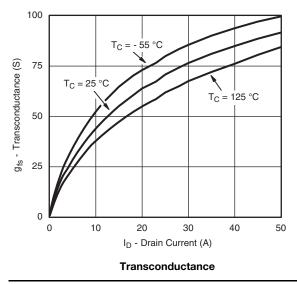
0.5

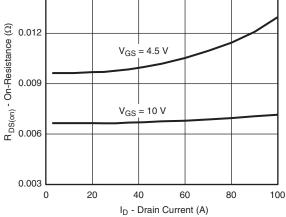
1.0

I_D - Drain Current (A)

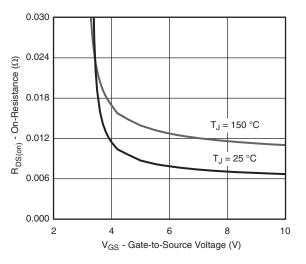
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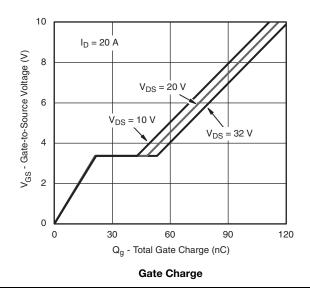




On-Resistance vs. Drain Current







S14-2535-Rev. B, 29-Dec-14

3

Document Number: 65594

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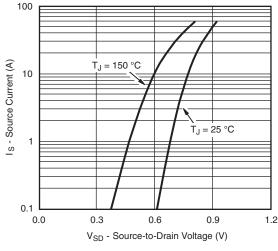
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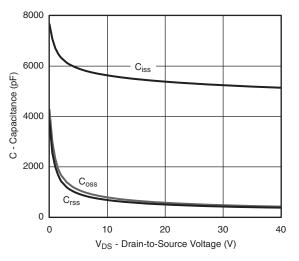
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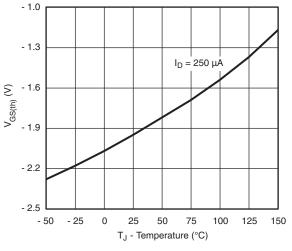
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



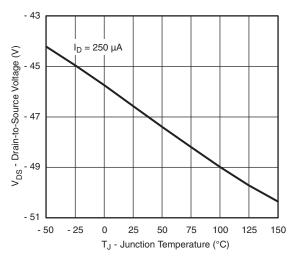
Source-Drain Diode Forward Voltage



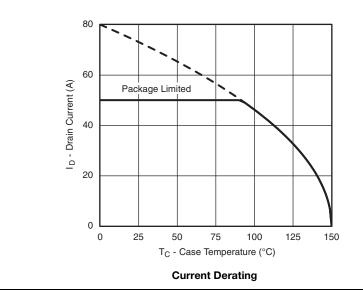




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



 $I_{\rm D} = 20 ~{\rm A}$ R_{DS(on)} - On-Resistance (Normalized) 1.7 $V_{GS} = 10 \text{ V}$ 1.4 V_{GS} = 4.5 V 1.1 0.8 0.5 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

S14-2535-Rev. B, 29-Dec-14

2.0

4

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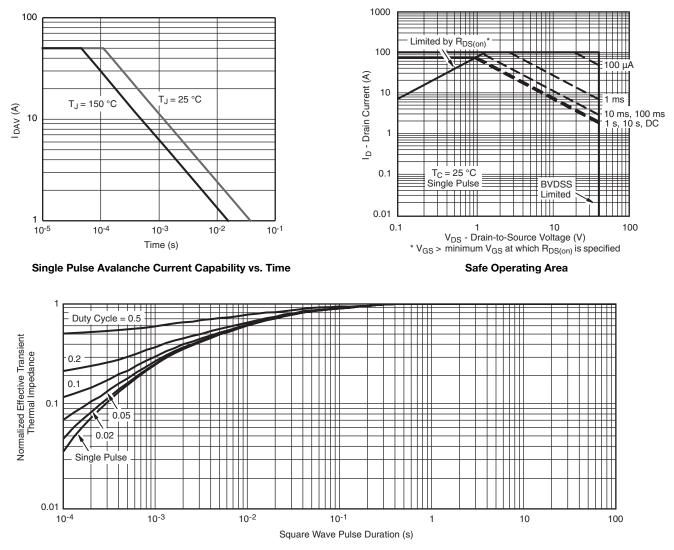
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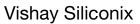
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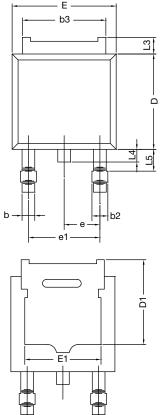
Normalized Thermal Transient Impedance, Junction-to-Case

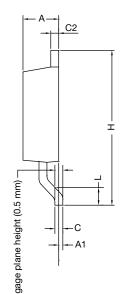
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TO-252AA Case Outline





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16- DWG: 534	0236-Rev. P, ⁻ 7	16-May-16			

Notes

• Dimension L3 is for reference only.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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